

# FT-212RH

## TECHNICAL SUPPLEMENT

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**YAESU MUSEN CO., LTD.**  
**C.P.O. BOX 1500**  
**TOKYO, JAPAN**

MANUALE DI SERV. X  
FT-212 RH  
05910738



This manual is intended to serve as a supplement to the FT-212RH Operating Manual. Detailed information regarding functions, specifications, options and operation has been provided in the Operating Manual, and is not reprinted herein. Therefore, this supplement is not intended to serve as an independent reference, but to be used in conjunction with the information provided in the Operating Manual.

Because of the compactness and complexity of the double-sided glass-epoxy circuit boards used in the FT-212RH, four layout diagrams are provided for each board. Each side of the board is identified by the type of the majority of components installed on that side. In most cases one side has only chip components, and the other has either a mixture of both chip and lead components (trimmers, coils, electrolytic capacitors, packaged ICs, etc.), or lead components only. The two "obverse" views depict the board as it is seen when viewed directly with the eye, while the two "reverse" views depict the unseen side of the board as it would appear if one were to peer through the board from the other side without seeing the components and tracks on the near side.

While we believe the technical information in this manual is correct, Yaesu assumes no liability for damage that may occur as a result of typographical or other errors that may be present. Your cooperation in pointing out any inconsistencies in the technical information would be appreciated.

Yaesu Musen reserves the right to make changes in the circuitry of this transceiver, in the interest of technological improvement, without notification of the owners.

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# CIRCUIT BOARD ACCESS

## BOTTOM COVER REMOVAL

The following circuit boards are accessed by removing the bottom cover:

- Main Unit\* (component side)
- IF Unit\*
- Mic Unit\*
- APC Unit
- VCO Unit
- PA Unit (lower edge only)

To remove the bottom cover, remove the four screws marked "★" in Figure 1, plus the four marked "※" if the top cover has not already been removed. Then lift the cover away.

\* To access these boards it may be necessary to remove the loudspeaker and holder:

- (1) Referring to Figure 2, unplug the speaker wire connector from J1005 on the Main Unit, and lift the loudspeaker out of its bracket.
- (2) Remove the three screws in the arms of the speaker bracket and remove the bracket.

## TOP COVER REMOVAL

Removing the top cover exposes the Solder Side of the Main Unit circuit board and the top edge of the PA Unit board.

To remove the top cover, remove the four screws marked "◎" in Figure 1, plus the four marked "※" if the bottom cover has not already been removed. Then lift the cover away.

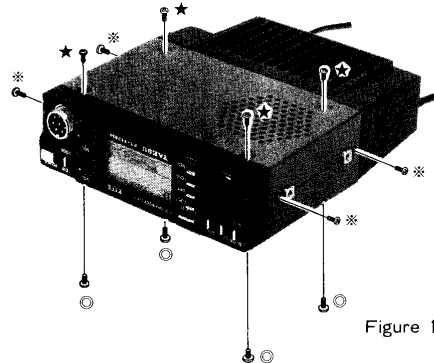


Figure 1

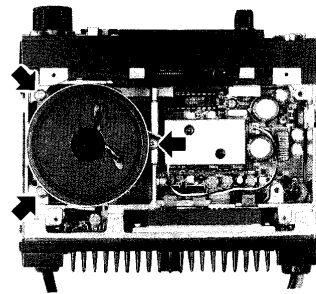


Figure 2

## FRONT PANEL REMOVAL

Removing the front panel allows access to the Control Unit and LCD Unit circuit boards.

- (1) After the top and bottom covers have been removed, pull off the Selector, VOL and SQL knobs.
- (2) Remove the nut from the microphone jack using a slotted ring wrench as shown in Figure 3.

The front panel can now be slid forward.

# CIRCUIT BOARD ACCESS

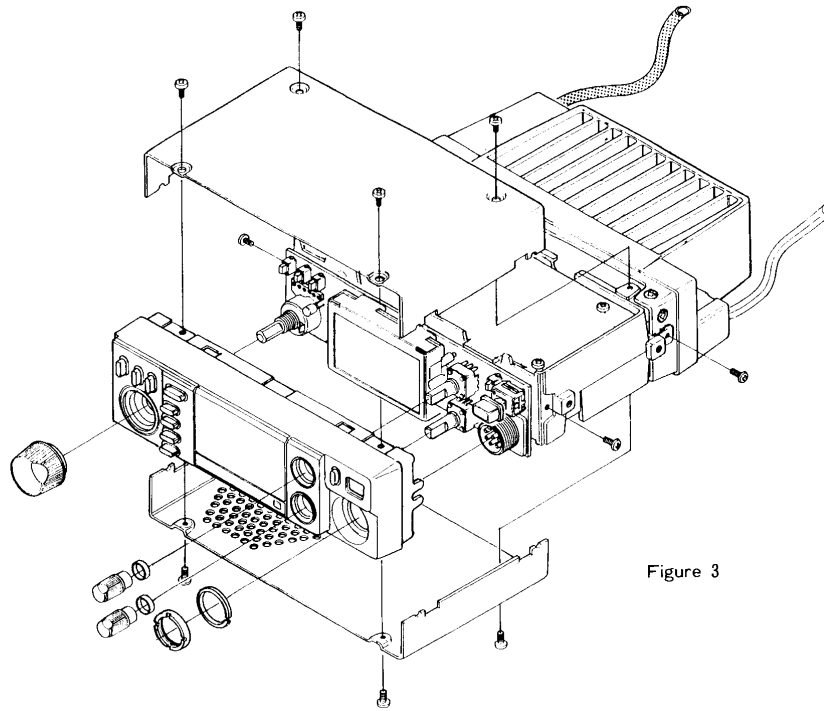
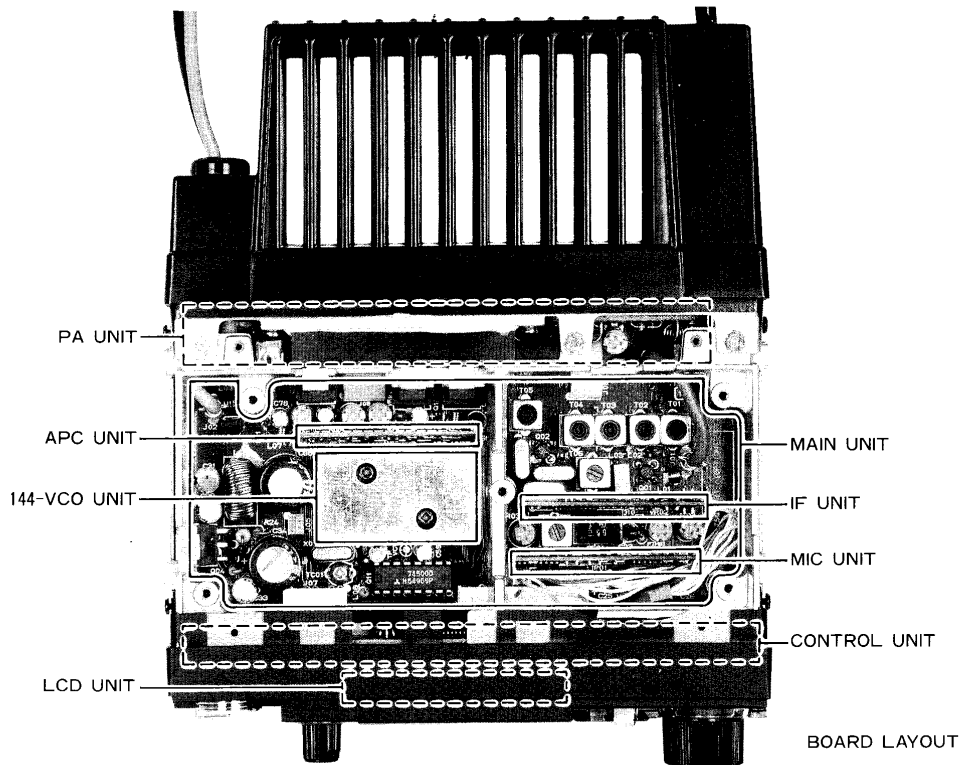


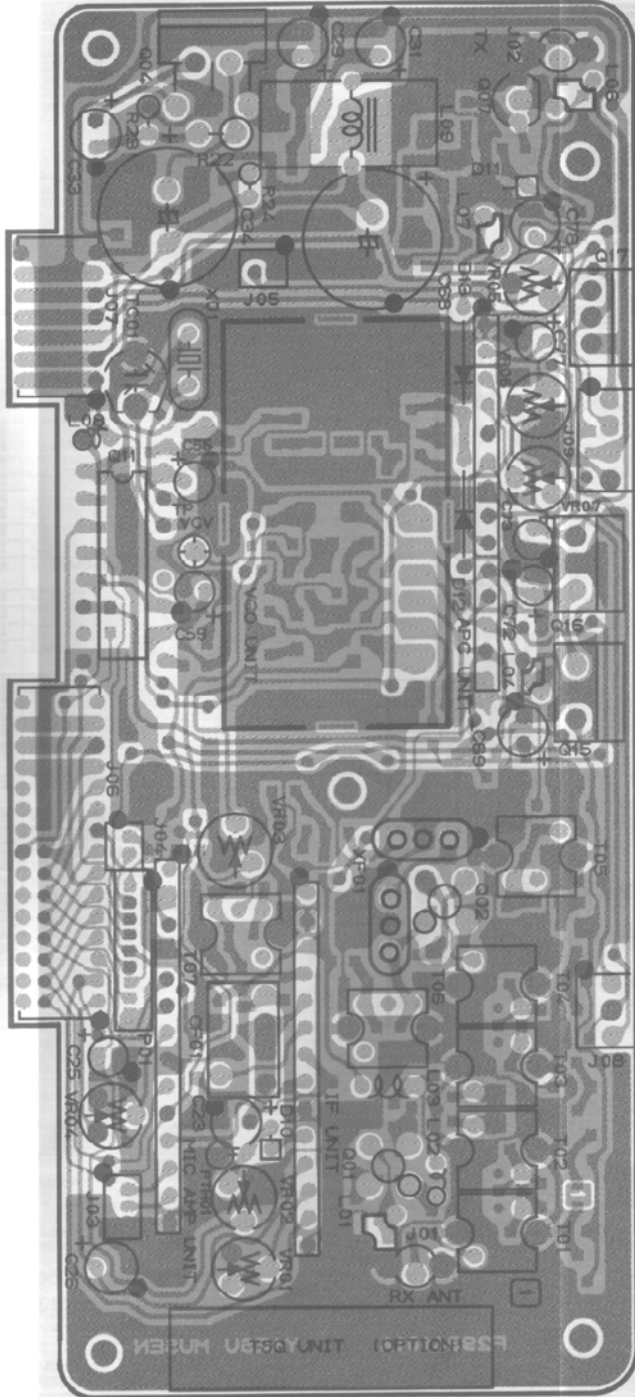
Figure 3



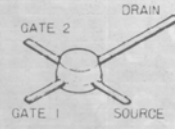
BOARD LAYOUT

# MAIN UNIT PARTS LAYOUT

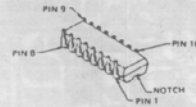
MAIN UNIT (No. 1XXX)



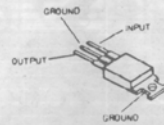
obverse view of "component" side



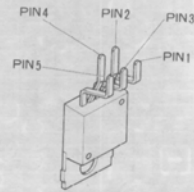
3SK81 (Q1002)  
3SK122L (Q1001)



M54959P(Q1011)

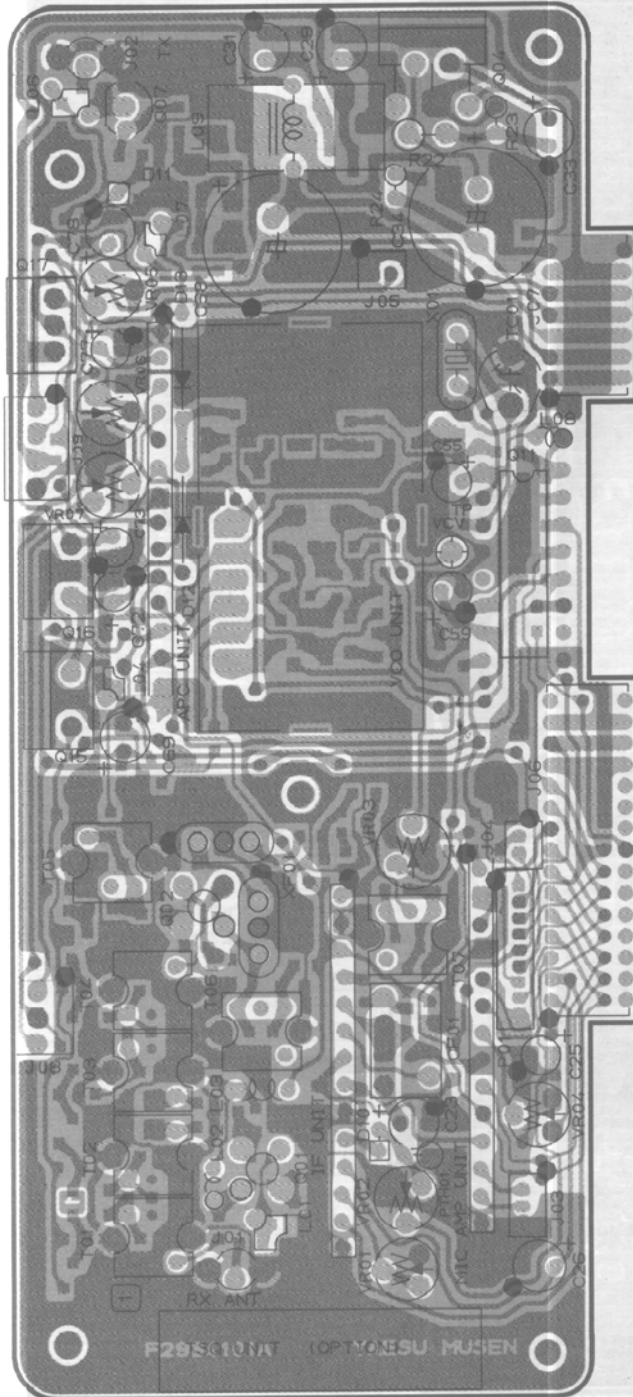


μPC7805H (Q1015)  
L7809 (Q1016)

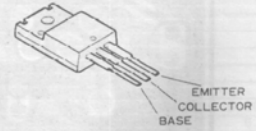


TDA2003 (Q1004)

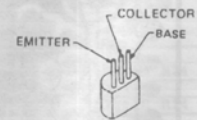
# MAIN UNIT PARTS LAYOUT



reverse view of "component" side



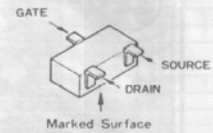
2SB1134R (Q1017)



2SC2538 (Q1007)

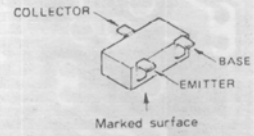
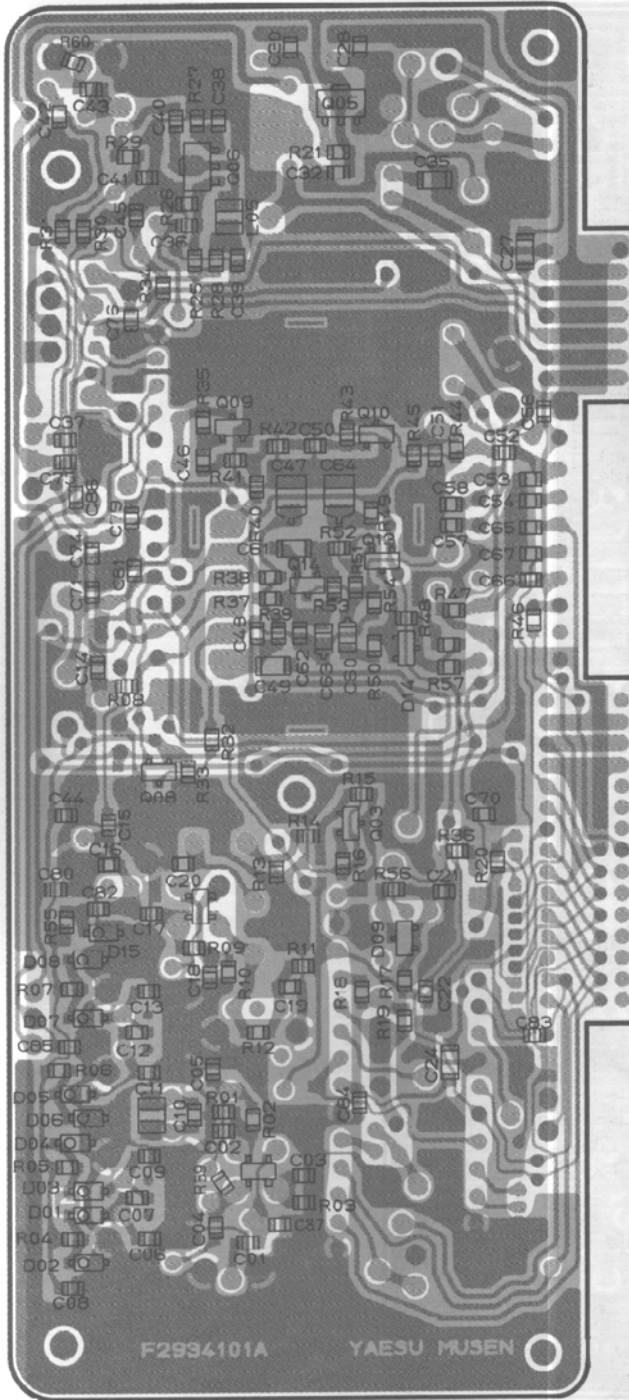


2SD1000(LL) (Q1005)  
2SC3357(RK) (Q1006)

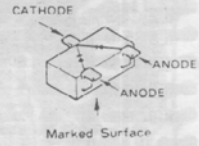


2SK209GR(XG) (Q1008)  
2SK208Y (JY) (Q1013)

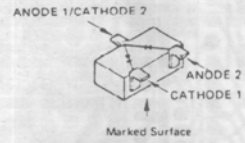
# MAIN UNIT PARTS LAYOUT



2SC2620(QB)  
(Q1003,1009,1010)  
2SC1623(L7) (Q1014)



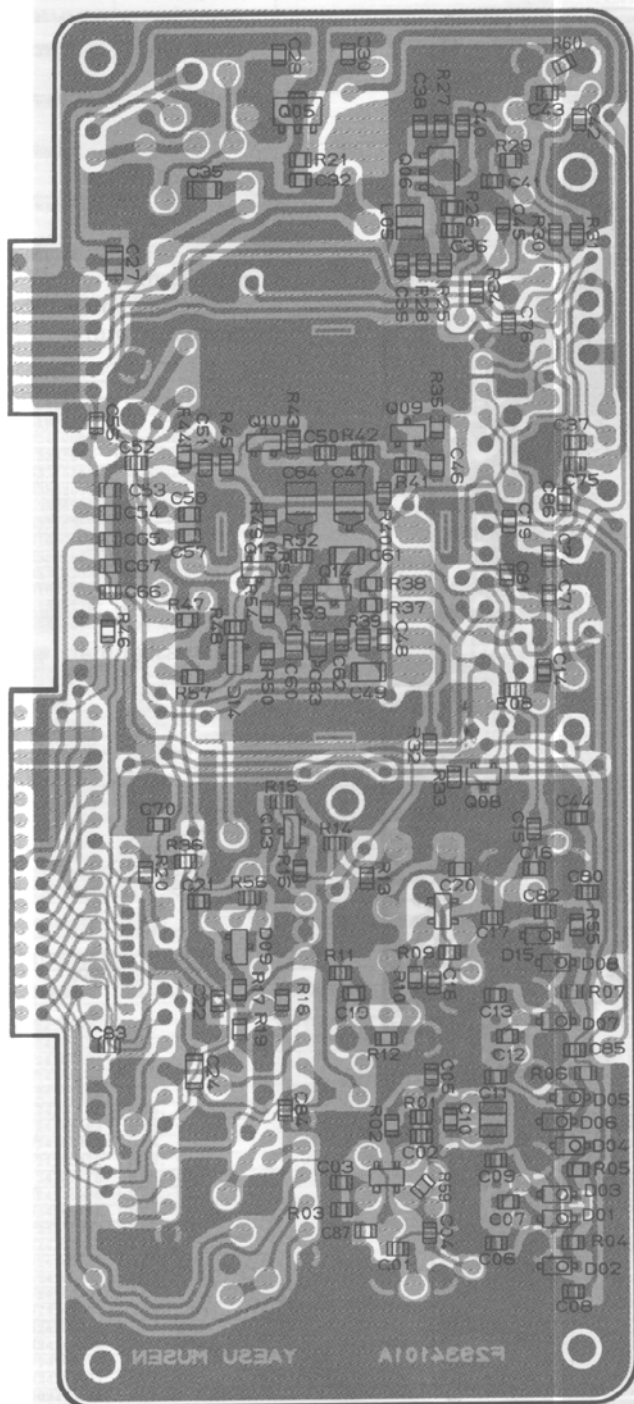
1SS184(B3) (D1014)



1SS226(C3) (D1009)

obverse view of "chip-only" side

# MAIN UNIT PARTS LAYOUT



reverse view of "chip-only" side



# MAIN UNIT PARTS LAYOUT

## MAIN UNIT VOLTAGE CHART

(DC VOLTS)

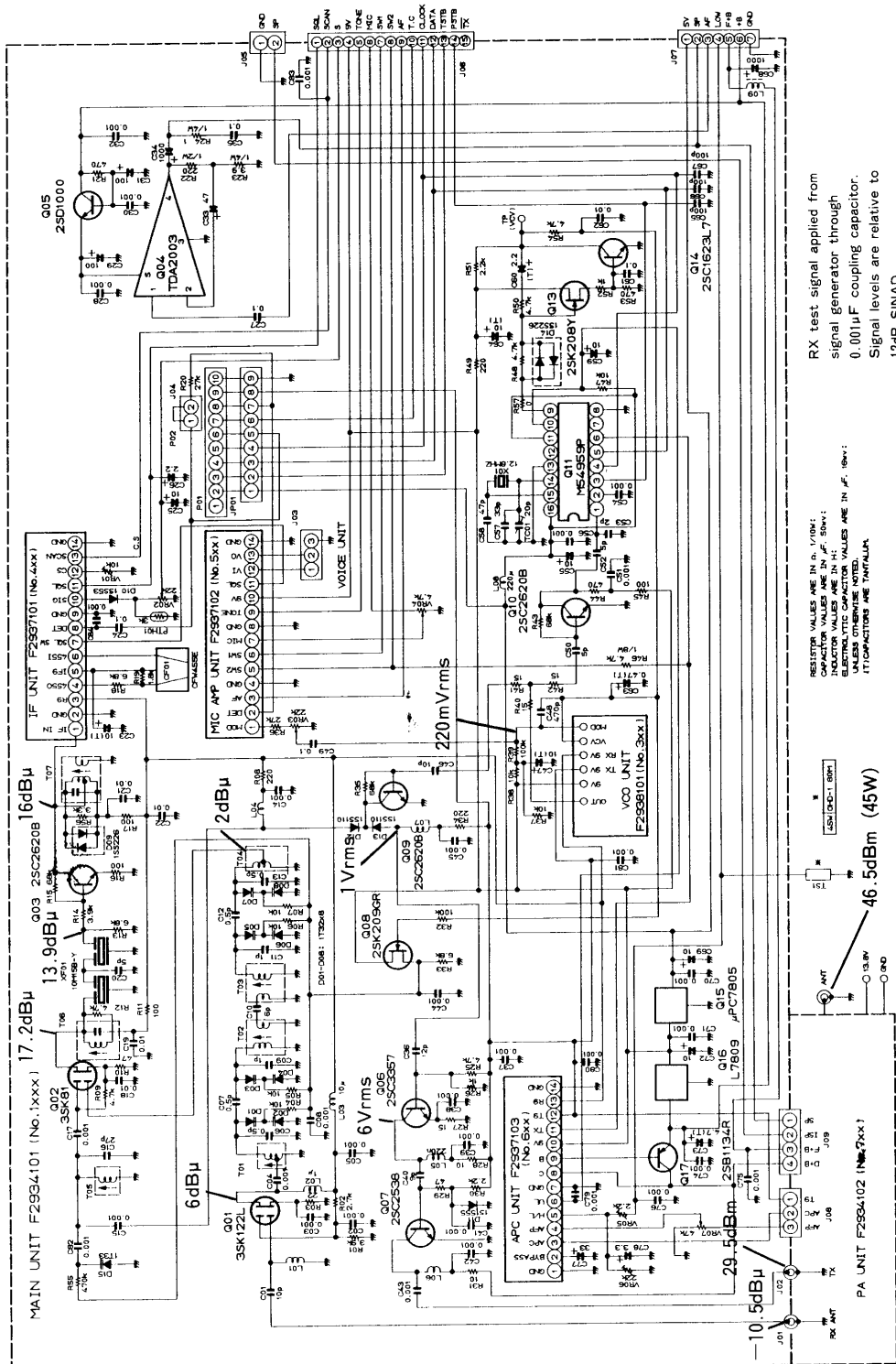
Symbol No.	E(S)	C(D)	B(G1)	G2	REMARKS
Q1001	0.2	9.0	0	5.2	
Q1002	0.18	8.60	0	0.15	
Q1003	0.2	8.8	0.8		
Q1005	12.8	13.6	13.6		
Q1006	0.6	8.5	1.0		
Q1007	0	11.80/3.50	0.55/0.55		RF POWER HIGH/LOW
Q1008	13.8	9.0	13.8		
Q1009	0	6.5	0.7		
Q1010	0	5.4	0.7		
Q1013	13.8	8.0	13.8		
Q1014	0	13.8	0.6		
Q1017	12.4/13.6	12.4/0	11.2/13.2		RX/TX

## MAIN UNIT IC VOLTAGE CHART

(DC VOLTS)

PIN No. Symbol No.	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	REMARKS	
Q1004	0.7	0.7	0	6.4	13.6													
Q1011	2.3	2.6	4.4	0	0	0/3.6	0	0	1.5	0	4.6	0	0	2.0	2.0	4.6	RX/TX	
Q1015	13.6	0	9.0															
Q1016	9.0	0	5.0															

# MAIN UNIT CIRCUIT DIAGRAM

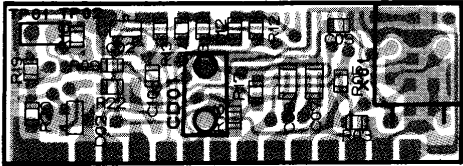


RESISTOR VALUES ARE IN  $\Omega$ ,  $\text{k}\Omega$ ,  $\text{M}\Omega$ .  
 INDUCTOR VALUES ARE IN  $\mu\text{H}$ ,  $\text{mH}$ ,  $\text{H}$ .  
 ELECTROLYTIC CAPACITOR VALUES ARE IN  $\mu\text{F}$ ,  $100\mu\text{F}$ .  
 UNLESS OTHERWISE NOTED,  
 ALL CAPACITORS ARE TANTALUM.

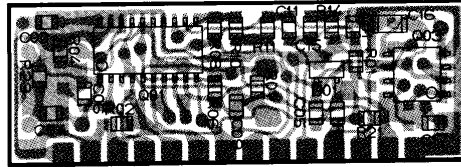
RX test signal applied from  
 signal generator through  
 0.001  $\mu\text{F}$  coupling capacitor.  
 Signal levels are relative to  
 12dB SINAD.

# IF UNIT PARTS LAYOUT/CIRCUIT DIAGRAM

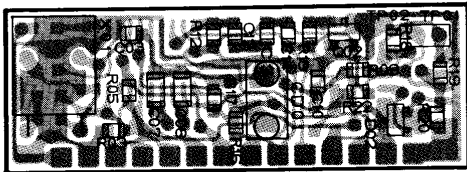
## IF UNIT (No. 4xx)



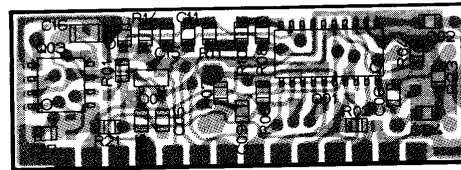
obverse view of "mixed-component" side



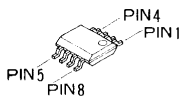
obverse view of "chip-only" side



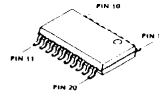
reverse view of "mixed-component" side



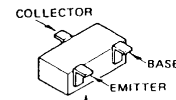
reverse view of "chip-only" side



M5223FP (Q403)



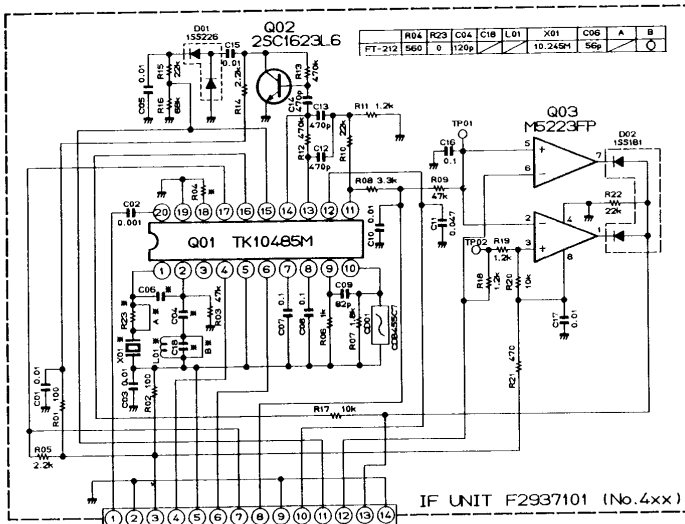
TK10487M (Q401)



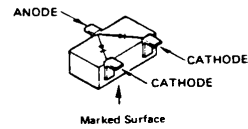
2SC1623(L6) (Q402)

## IF UNIT VOLTAGE CHART (DC VOLTS)

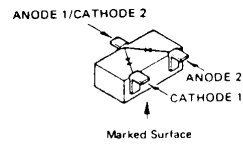
1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	REMARKS	
FM IN	GND	Rx 9V	45.0V	IF 9	45 V	SOL SW	DET	GND	SIG	SOL	CS	SCAN	GND								
8.7/0	0	9.0/0	8.0/0	8.4/0	6.6/0	50.0V 50.0M 0V 74.0	3.2/0	0		0.2-16/10	2.7/0	50.0V 50.0M 50V 50M	0								RX/TX



RESISTOR VALUES ARE IN Ω, 1/10Ω;  
CAPACITOR VALUES ARE IN μF, 50V;  
INDUCTOR VALUES ARE IN H;  
UNLESS OTHERWISE NOTED.



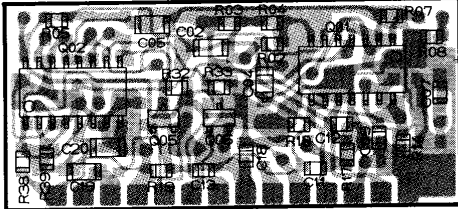
1SS181(A3) (D402)



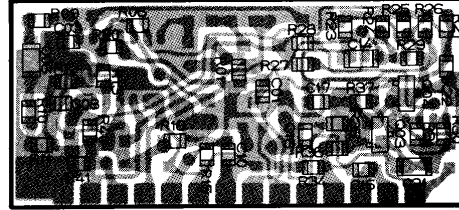
1SS226(C3) (D401)

# MIC UNIT PARTS LAYOUT/CIRCUIT DIAGRAM

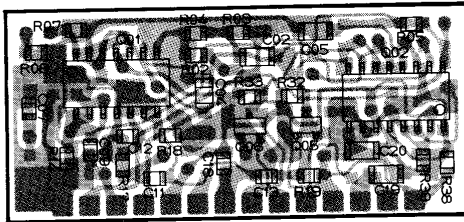
MIC UNIT (No. 5 × X)



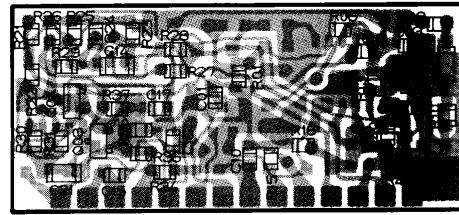
obverse view of "IC" side



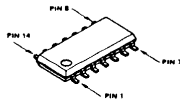
obverse view of "chip-only" side



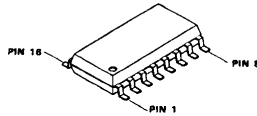
reverse view of "IC" side



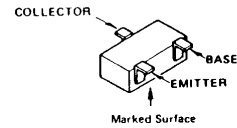
reverse view of "chip-only" side



LA6324M (Q501)



μPD4052BG (Q502)

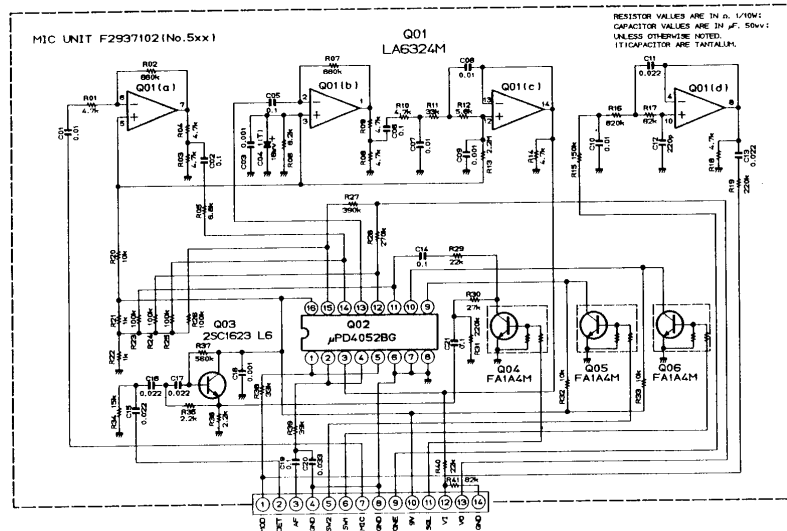


2SC1623(L6) (Q503)  
FA1A4M-T2B (L33)  
(Q504-506)

## MIC UNIT VOLTAGE CHART

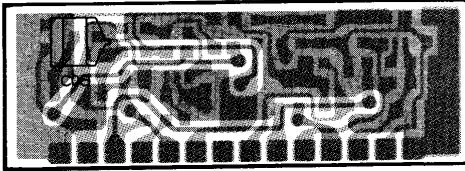
(DC VOLTS)

1	2	3	4	5	6	7	8	9	10	11	12	13	14	REMARKS
MOD	DET	AF	GND	SW2	SW1	MIC	GND	9V	TONE	SOL	V1	V0	GND	RX/TX
0/2.1			0	0/4.3	0	0	0	1.6/1.6	9.0/9.0	0	3.0/3.0	3.0/9.0	0	

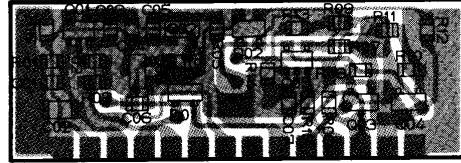


# APC UNIT PARTS LAYOUT/CIRCUIT DIAGRAM

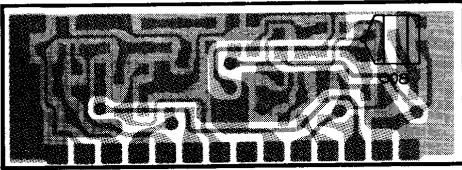
## APC UNIT (No. 6xx)



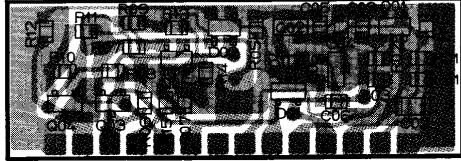
obverse view of "Tantalum CAP" side



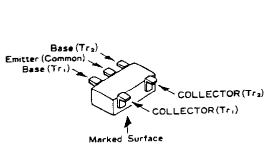
obverse view of "chip-only" side



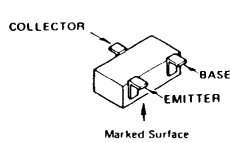
reverse view of "Tantalum CAP" side



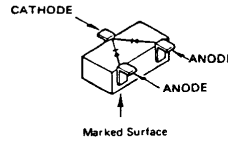
reverse view of "chip-only" side



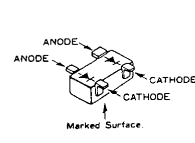
FMS1(S1) (Q601)  
FMW1(W1) (Q605)



2SB624(BV4) (Q603, Q604)  
2SC1623(L6) (Q602)  
FA1A4M-T2B(L33) (Q606)



1SS184(B3) (D601)

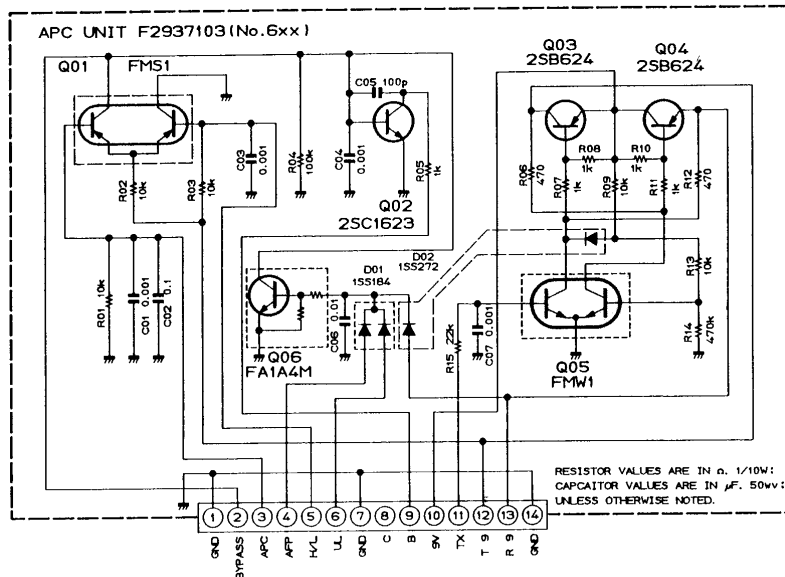


1SS272(A1) (D602)

### APC UNIT VOLTAGE CHART

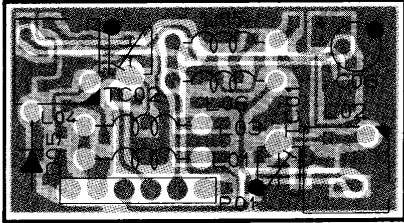
(DC VOLTS)

1	2	3	4	5	6	7	8	9	10	11	12	13	14	REMARKS
GND	BYPASS	APC	AFF	H/L	UL	GND	C	B	9V	TX	T9	R9	GND	
0	0/0,6	0/5,7	0	0/1,2 0/1,2	0,1/0,1	0	0/3,7	13,6/13,2	9,0/9,0	0/3,6	0/9,0	9,0/0	0	RX/TX

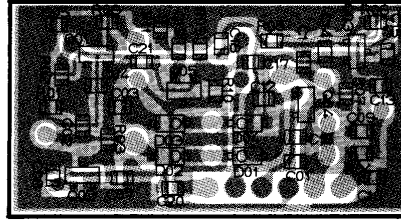


# 144-VCO UNIT PARTS LAYOUT/CIRCUIT DIAGRAM

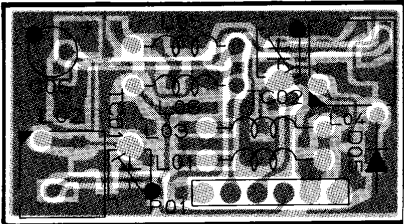
144-VCO UNIT (No. 3XX)



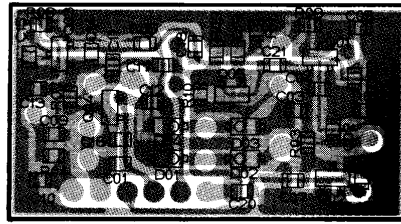
obverse view of "component" side



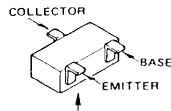
obverse view of "chip-only" side



reverse view of "component" side



reverse view of "chip-only" side



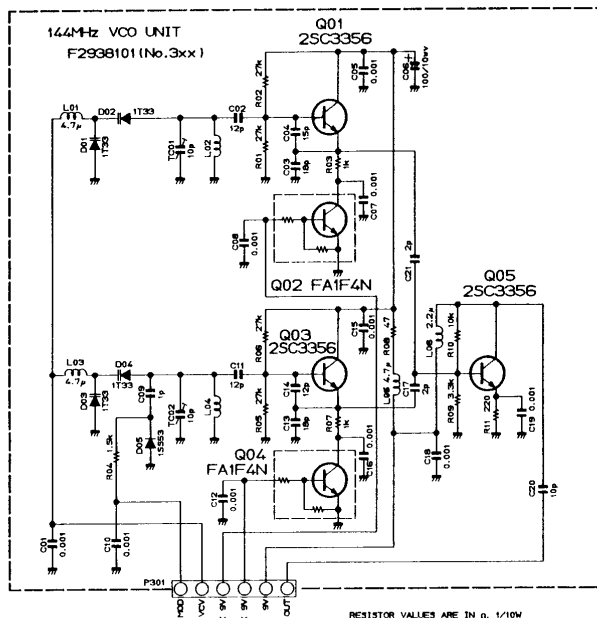
Marked Surface

- 2SC3356(R24)  
(Q301,303,305)
- FA1F4N-T2B(R24)  
(Q302,304)

## VCO UNIT VOLTAGE CHART

(DC VOLTS)

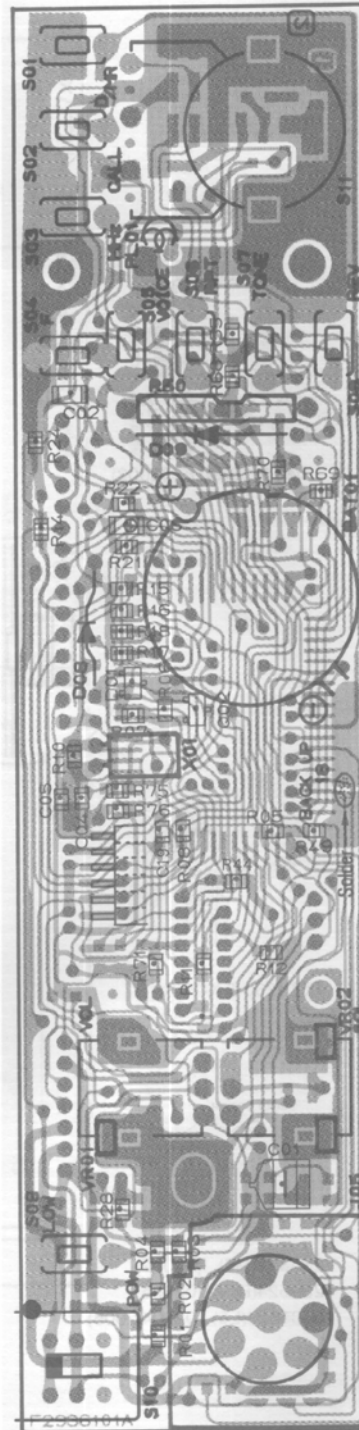
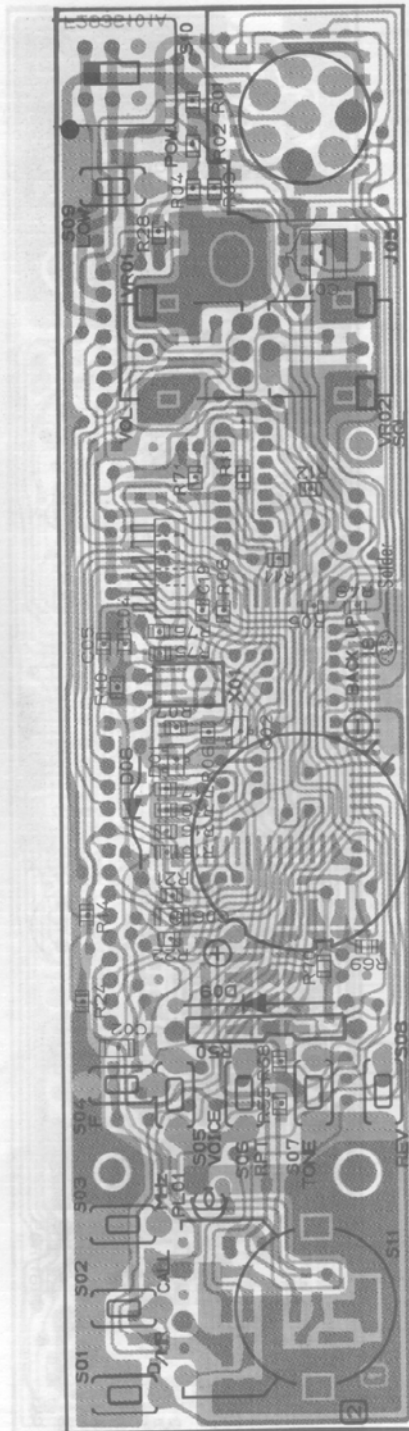
MOD	VCV	R9	T9	9	OUT	REMARKS
3.6		9.0/0	0/9.0	9.0	0	RX/TX



RESISTOR VALUES ARE IN Ω, 1/10W  
CAPACITOR VALUES ARE IN μF, 50V  
INDUCTOR VALUES ARE IN H; UNLESS OTHERWISE NOTED.

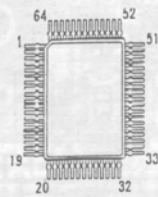
# CONTROL UNIT PARTS LAYOUT

CONTROL UNIT (No. 2XXX)

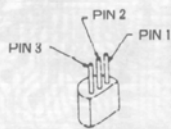
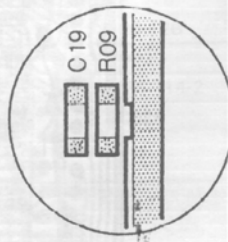


obverse view of "mixed-component" side    reverse view of "mixed-component" side

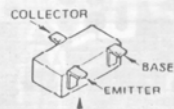
# CONTROL UNIT PARTS LAYOUT



HD404418A01F (U20U3)

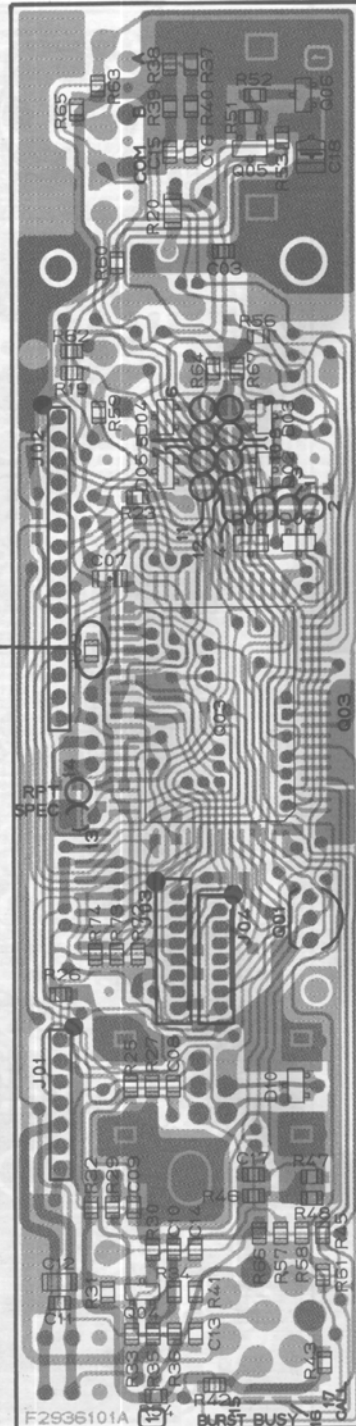


PST5230-2 (Q2001)



Marked Surface

- 2SA812(M6) (Q2002)
- 2SB624(BV4) (Q2005)
- 2SC1623(L6) (Q2004,2006)

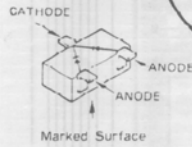
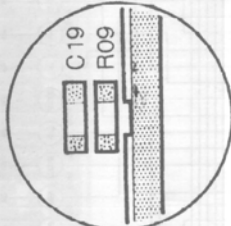
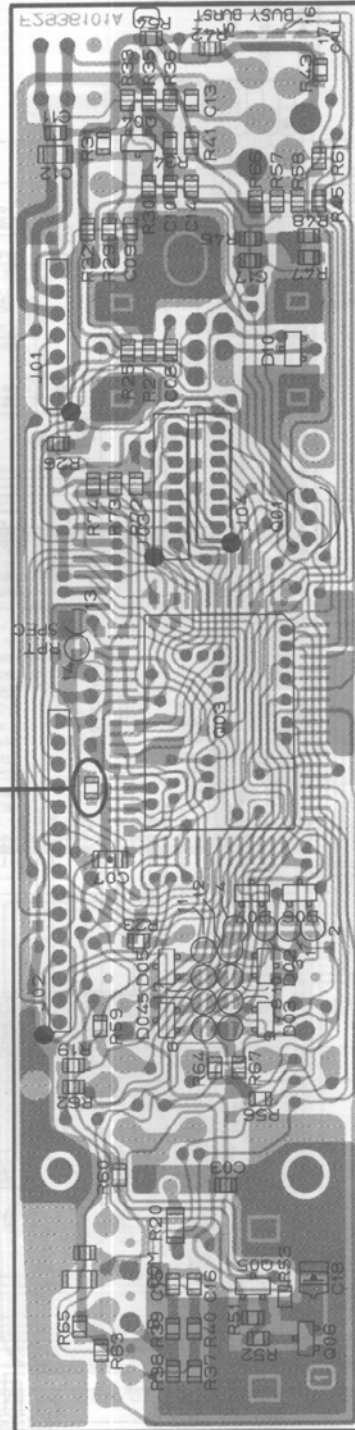


obverse view of "IC" side

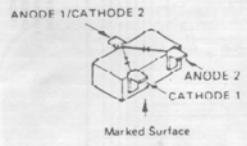
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# CONTROL UNIT PARTS LAYOUT



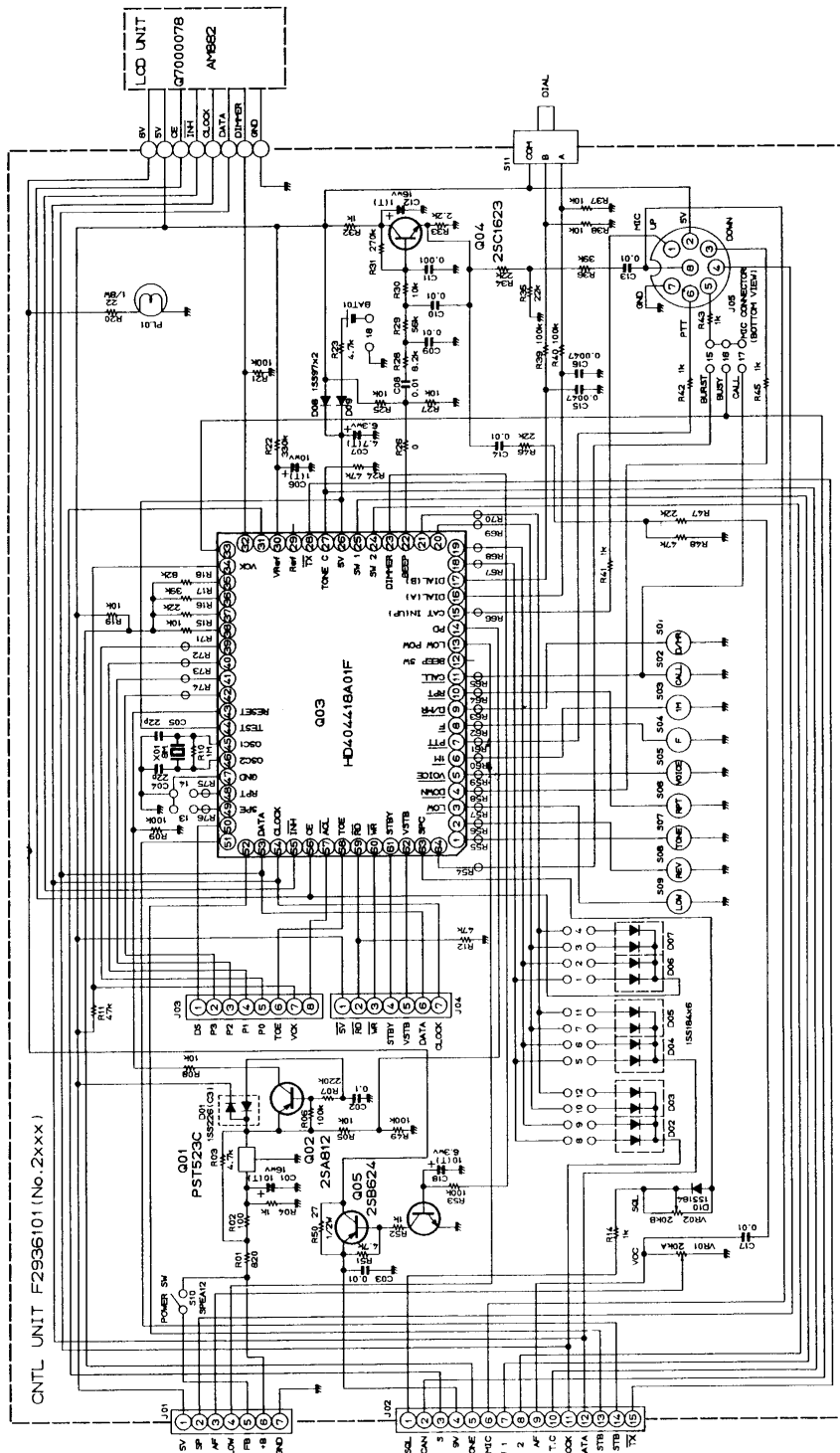
1SS184(B3)  
 (D2002,2003,2004)  
 2005,2006,2007  
 2010



1SS226(C3) (D2001)

obverse view of "IC" side

# CONTROL UNIT CIRCUIT DIAGRAM



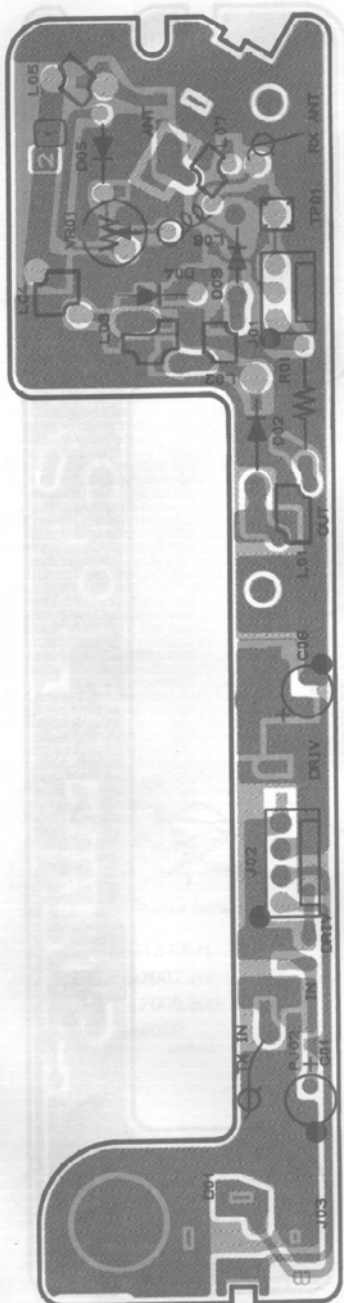
RESISTOR VALUES ARE IN  $\Omega$ , 1/10K;  
 CAPACITOR VALUES ARE IN  $\mu$ F, 50V;  
 UNLESS OTHERWISE SPECIFIED.  
 (1) CAPACITORS ARE TANTALUM.

RESISTOR VALUES ARE IN  $\Omega$ , 1/10K;  
 CAPACITOR VALUES ARE IN  $\mu$ F, 50V;  
 UNLESS OTHERWISE SPECIFIED.  
 (1) CAPACITORS ARE TANTALUM.

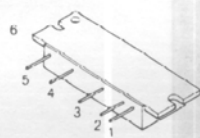
- 1 B50
- 2 B51
- 3 B52
- 4 B53
- 5 JF1
- 6 JF2
- 7 B72
- 8 S520
- 9 S531
- 10 P53
- 11 S7E
- 12 S7E
- 13 S7E
- 14 S7E
- 15 S7E
- 16 S7E
- 17 S7E
- 18 S7E
- 19 S7E
- 20 S7E

# PA UNIT PARTS LAYOUT

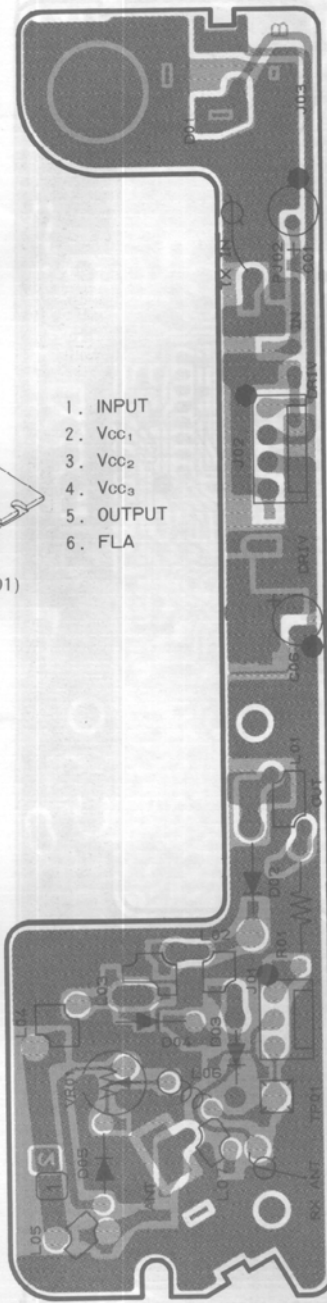
PA UNIT (No.7XX)



obverse view of "component" side



M57726 (Q701)

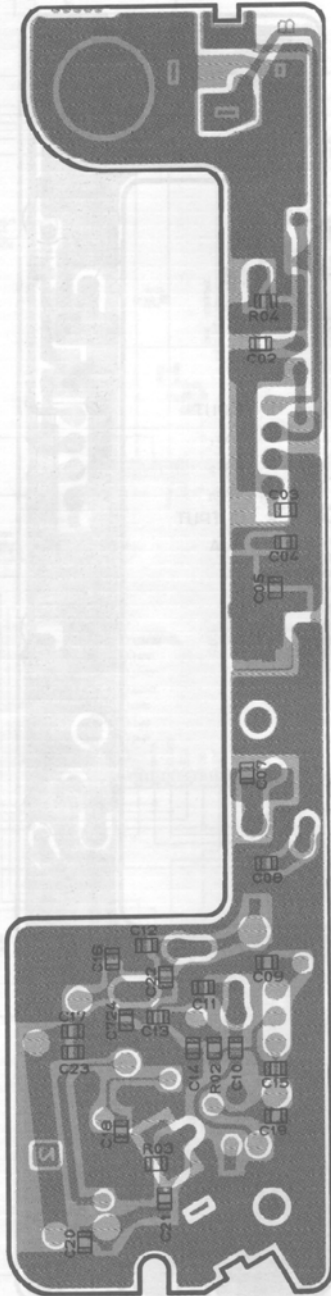


reverse view of "component" side

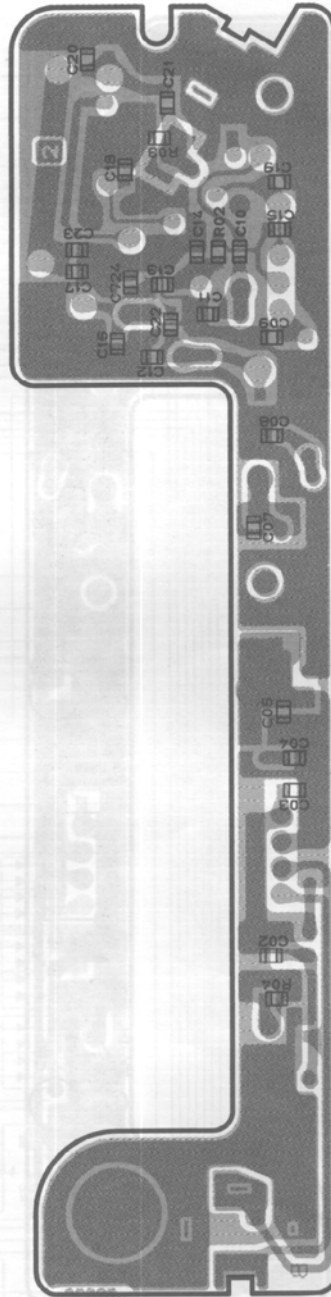
obverse view of "IC" side

# PA UNIT PARTS LAYOUT

PA UNIT (No. TX)

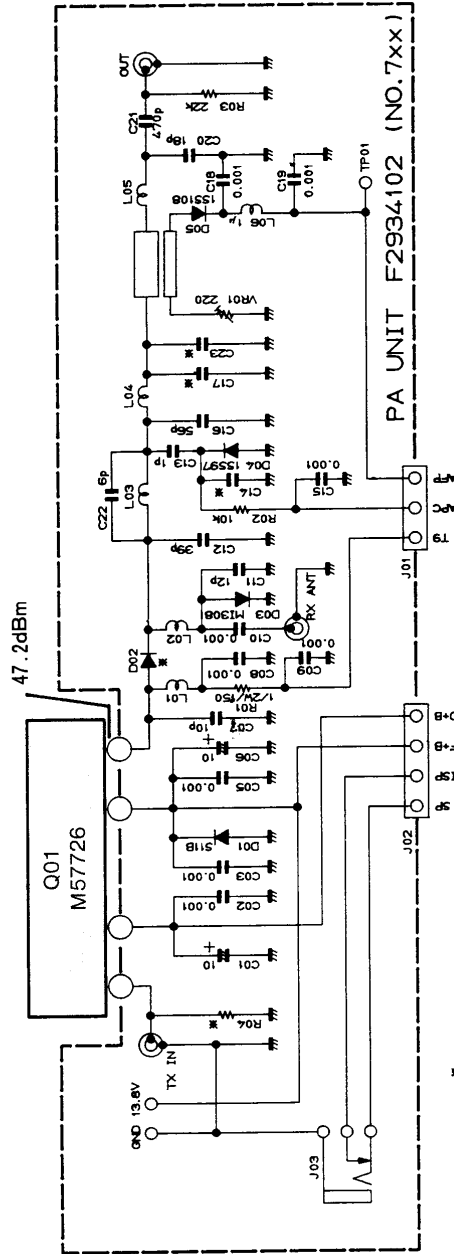


obverse view of "chip-only" side



reverse view of "chip-only" side

# PA UNIT CIRCUIT DIAGRAM



RESISTOR VALUES ARE IN  $\Omega$ , 1/10W;  
 CAPACITOR VALUES ARE IN  $\mu$ F, 50V;  
 INDUCTOR VALUES ARE IN H;  
 ELECTROLYTIC CAPACITOR VALUES ARE IN  $\mu$ F, 16V;  
 UNLESS OTHERWISE NOTED.

Q01	D02	R04	C14	C17	C23
45V M57726	1N914	10k	3p	27n	27n

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*Scanned by [Signature]*

# SEMICONDUCTOR CROSS-REFERENCE

## ◎ MAIN UNIT

Symbol No.	ORIGINAL	REPLACEMENT	REPLACEMENT	REPLACEMENT
	Part No.	Part No.	Part No.	Part No.
Q1004	TDA2003	μPC2002V		
	G1090769	G1090284		
Q1014	2SC1623-T2BL7	2SC2712BL TE85R	2SC2462 LDTR	2SC2812 L7TR
	G3316237G	G3327127B	G3324627D	G3328127G
Q1015	μPC7805H	L7805		
	G1090299	G1090776		
D1009	1SS226 TE85R	1SS123-T2B		
	G2070003	G2070020		
D1014	1SS184 TE85R	MC2838-T14-2	DCB015-TA	
	G2070009	G2070018	G2070012	

## ◎ IF UNIT

Symbol No.	ORIGINAL	REPLACEMENT	REPLACEMENT	REPLACEMENT
	Part No.	Part No.	Part No.	Part No.
Q402	2SC1623-T2BL6	2SC2712GR TE85R	2SC2462 LCTR	2SC2812 L6TR
	G3316237F	G3327127G	G334627C	G3328127F
Q401	1SS226 TE85R	1SS123-T2B		
	G2070003	G2070020		
D402	1SS181 TE85R	MC2836-T14-2	DCA015-TA	
	G2070001	G2070024	G2070014	

## ◎ MIC UNIT

Symbol No.	ORIGINAL	REPLACEMENT	REPLACEMENT	REPLACEMENT
	Part No.	Part No.	Part No.	Part No.
Q501	LA6324M	μPC324G		
	G1090559	G1090603		
Q503	2SC1623-T2BL6	2SC2712GR TE85R	2SC2462 LCTR	2SC2812 L6TR
	G3316237F	G3327127G	G3324627C	G3328127F

## ◎ APC UNIT

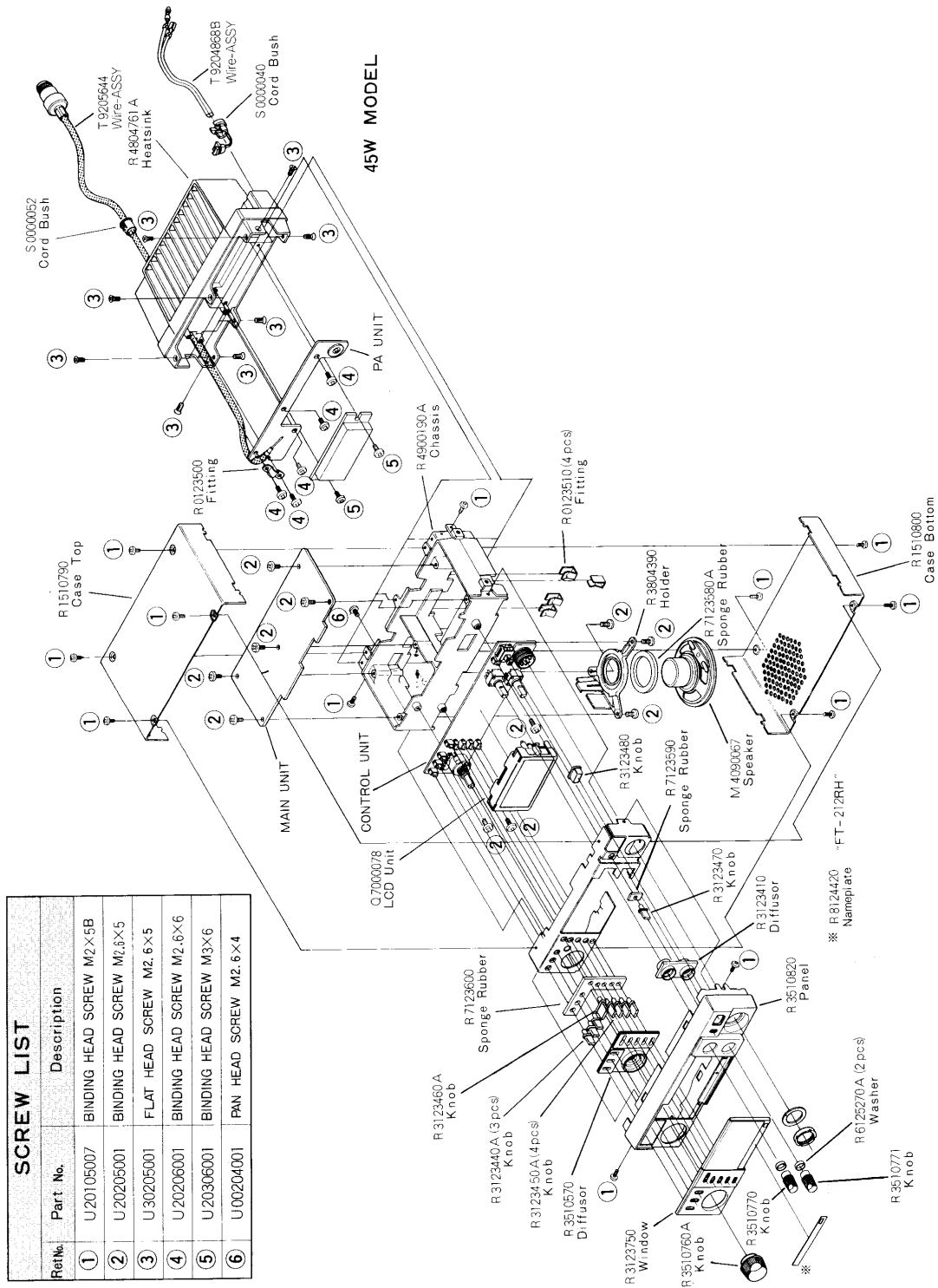
Symbol No.	ORIGINAL	REPLACEMENT	REPLACEMENT	REPLACEMENT
	Part No.	Part No.	Part No.	Part No.
Q602	2SC1623-T2BL6	2SC2712GR TE85R	2SC2462 LCTR	2SC2812 L6TR
	G3316237F	G3327127G	G3324627C	G3328127F
D601	1SS184 TE85R	MC2838-T14-2	DCB015-TA	
	G2070009	G2070018	G2070012	

## ◎ CONTROL UNIT

Symbol No.	ORIGINAL	REPLACEMENT	REPLACEMENT	REPLACEMENT
	Part No.	Part No.	Part No.	Part No.
Q2002	2SA812-T2BM6B	2SA1162GR TE85R	2SA1052 MCTR	2SA1179 M6TR
	G3108127F	G3111627G	G3110527C	G3111797E
Q2004,2006	2SC1623-T2BL6	2SC2712GR TE85R	2SC2462 LCTR	2SC2812 L6TR
	G3316237F	G3327127G	G3324627C	G3328127F
D2001	1SS226 TE85R	1SS123-T2B		
	G2070003	G2070020		
D2002,2003,2004 2005,2006,2007 2010	1SS184 TE85R	MC2838-T14-2	DCB015-TA	
	G2070009	G2070018	G2070012	



# EXPLODED VIEW





# ALIGNMENT

The high reliability of the chip components in the FT-212RH minimize the possibility that repair or realignment should be needed after leaving the factory. However, if damage occurs and some parts subsequently be replaced, realignment may be required. If a sudden problem occurs during normal operation, it is likely due to component failure; realignment should not be done until after the faulty component has been replaced.

Because of the compact circuitry of this transceiver, we recommend that servicing be performed only by authorized Yaesu service technicians who are experienced with the circuitry and fully equipped for repair and alignment. Therefore, if a fault is suspected, contact the dealer from whom the transceiver was purchased for instructions regarding repair. Authorized Yaesu service technicians realign all circuits and make complete performance checks to ensure compliance with factory specifications after replacing any faulty components.

Those who do undertake any of the following alignments are cautioned to proceed at their own risk. Yaesu must reserve the right to change circuits and alignment procedures in the interest of improved performance, without notifying owners.

No alignment should be attempted unless the normal function and operation of the transceiver are clearly understood, the cause of the malfunction has been clearly pinpointed and any faulty components replaced, and the need for realignment determined to be absolutely necessary.

The following test equipment (and thorough familiarity with its correct use) is necessary for complete realignment. Correction of problems caused by misalignment resulting from use of improper test equipment is not covered under the warranty policy.

A 50-ohm dummy load that is non-reactive up to 150 MHz is required. Correct alignment is not possible with an antenna.

## Alignment Equipment

DC voltmeter (at least 20-kilohms/volt)  
150 MHz standard signal generator (SSG) with calibrated level and modulation (see note below)  
AF signal generator  
SINAD meter (SINADDER)  
FM linear detector (deviation meter)  
CM coupler (directional coupler)  
RF wattmeter (50W,  $\pm 5\%$  @ 150MHz)  
50-ohm non-reactive (@150 MHz) dummy load  
Frequency counter (100Hz resolution at 150MHz)  
Oscilloscope (recommended, not required)

Note: SSG levels referred to in the alignment procedure are based on  $0\text{dBu}=0.5\text{uV}$ .

## Alignment Precautions

Correct alignment requires that the ambient temperature be the same as that of the transceiver and test equipment, and that this temperature be held constant between 20 and 30 °C (68 to 86 °F). When the transceiver is brought into the shop it should be allowed at least 2 hours for thermal equalization before alignment.

Alignments must not be made unless the oscillator shields and circuit boards are firmly affixed in place. Also, the frequency counter must be thoroughly warmed up before beginning.

Supply voltage during alignment must be held constant at 13.8V DC. Use a well regulated, adjustable power supply capable of at least 10A continuous load.

# ALIGNMENT (PLL)

## A. PLL Unit

### 1) VCV (Varactor Control Voltage)

a) With the dummy load connected to the ANT jack, connect the DC voltmeter (3V scale) to the VCV terminal on the VCO Unit.

b) Tune the transceiver to the top edge of the band for the model being aligned, and while receiving, adjust TC301 on the VCO Unit for the voltage indicated below ( $\pm 0.1V$ ) for Receive at that frequency:

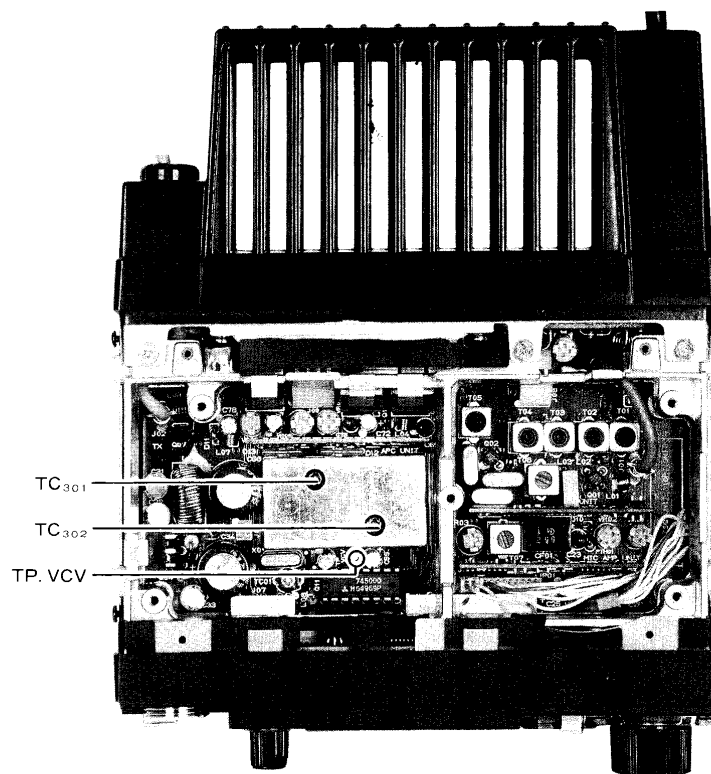
	Receive	Transmit
146 MHz	1.5V	1.4V
148 MHz	1.7V	1.6V

c) Retune the transceiver to 144 MHz and confirm at least 1.3V.

d) Retune to the top edge of the band, close the PTT line, and adjust TC302 for the voltage indicated above for Transmit.

e) Again retune to 144 MHz and confirm at least 1.2V on the meter while transmitting.

f) Repeat steps b - e several times, and then remove the voltmeter.



PLL ALIGNMENT POINTS

# (Transmitter) ALIGNMENT

## B. Transmitter

Set up the test equipment as shown in Figure 1. Close the PTT line when making adjustments. All adjustment points are on the Main Unit.

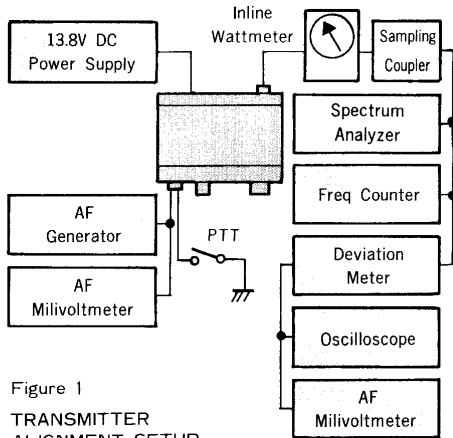


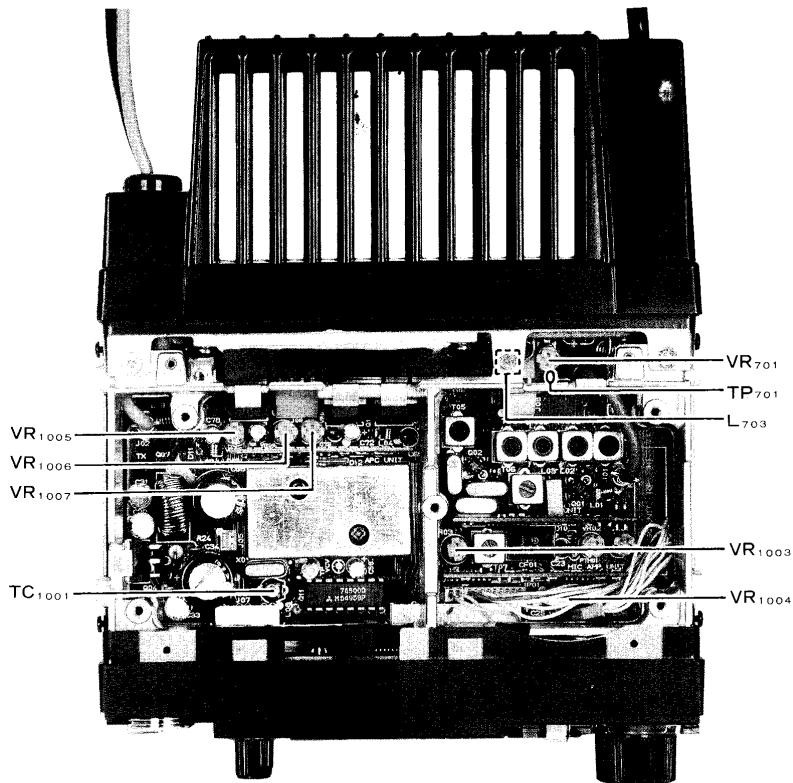
Figure 1  
TRANSMITTER  
ALIGNMENT SETUP

### 1) Early Stage Coupling

- a) Tune the transceiver to the center of the band, and set the LOW button to the high power position.
- b) Adjust L703 for maximum power output (at least 46 watts).

### 2) Power Output

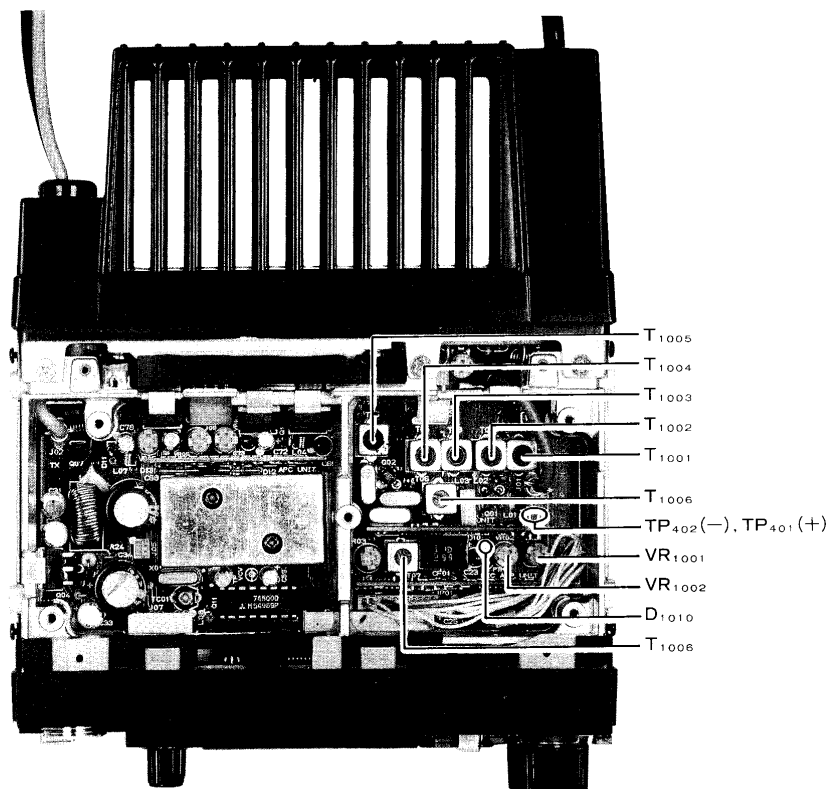
- a) With the transceiver tuned to the center of the band, set the LOW button to the high power position.
- b) Connect the DC voltmeter to TP701 on the PA Unit.
- c) Press the PTT switch and adjust VR701 for minimum on the voltmeter.



TRANSMITTER ALIGNMENT POINTS

## ALIGNMENT (Transmitter)

- d) Adjust VR1006 for 46 watts output.
- e) Press the LOW switch and adjust VR1005 for 5W output.
- 3) Frequency Calibration
- a) Adjust TC1001 to match the counter indication with the transceiver frequency.
- 4) Deviation
- a) Set the AF generator for 25mV output at 1 kHz. Adjust VR1003 for  $\pm 4.5$  kHz deviation on the Deviation Meter.
- b) Reduce the AF generator level to 5mV and adjust VR1004 for  $\pm 3.5$  kHz deviation.



RECEIVER ALIGNMENT POINTS

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## (Receiver) ALIGNMENT

### C. Receiver

Set up the test equipment as shown in Figure 2. All adjustment points are on the Main Unit.

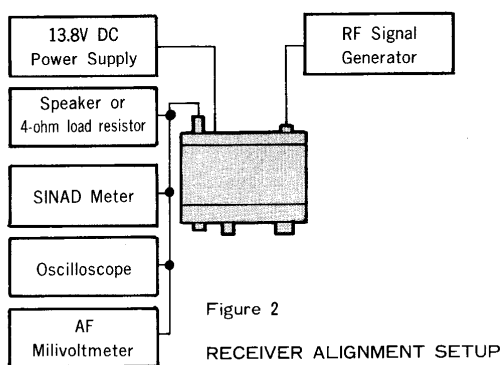


Figure 2

RECEIVER ALIGNMENT SETUP

#### 1) Interstage Transformers

- a) Connect the DC voltmeter between the cathode of D1010 and chassis ground.
- b) Modulate the RF signal generator for  $\pm 3.5$  kHz deviation of a 1 kHz tone.
- c) Tune the transceiver and signal generator to the same frequency at the center of the band, and set the injection level to produce midrange S-meter indication.
- d) Adjust T1001 through T1007 for maximum S-meter indication. Reduce the injection level, if

necessary, to keep the S-meter near midrange.

- e) Confirm 12dB SINAD sensitivity of -7.5dBu (0.21uV) or better on the SINADDER.

#### 2) S-Meter Calibration

- a) At the center of the band, set the signal generator for 30dBu (50uV) injection with  $\pm 3.5$  kHz deviation of a 1 kHz tone.
- b) Adjust VR1002 so that all S-meter segments are just on.

#### 3) Scanner Center-Stop

- a) Connect the DC voltmeter (3V range) between TP401 (+) and TP402 (-) on the IF Unit.
- b) Tune the transceiver to 146.000 MHz, and set the SQL fully counterclockwise (the BUSY lamp should be lit).
- c) Tune the signal generator also to 146.000 MHz, and inject 20dBu (5uV) with  $\pm 3.5$  kHz deviation of a 1 kHz tone.
- d) Adjust VR1001 for 0V on the voltmeter.









# PARTS LIST

P301	P0090473	Connector				R2041	J24205102	RES. Chip	1/10W	1k ohm
	R0123490	Shield Case				R2042	J24205102	RES. Chip	1/10W	1k ohm
	R0113730	Sprint Board				R2043	J24205102	RES. Chip	1/10W	1k ohm
<b>CONTROL UNIT</b>										
Symbol No.	Part No.	Description	Device			R2044	J24205473	RES. Chip	1/10W	47k ohm
	F2936101A	Printed Circuit Board				R2045	J24205102	RES. Chip	1/10W	1k ohm
	C029361AA	PCB with Component (Version A2)				R2046	J24205223	RES. Chip	1/10W	22k ohm
	C029361AB	PCB with Component (Version A1)				R2047	J24205223	RES. Chip	1/10W	22k ohm
	C029361AC	PCB with Component (Version A3,A4)				R2048	J24205473	RES. Chip	1/10W	47k ohm
	C029361AD	PCB with Component (Version B)				R2049	J24205104	RES. Chip	1/10W	100k ohm
	C029361AE	PCB with Component (Version F)				R2050	J01275270	Carbon Film RES.	1/2W	27 ohm
Q2001	G1090812	IC	PST523C-2			R2051	J24205472	RES. Chip	1/10W	4.7k ohm
Q2002	G3108127F	Transistor	2SA812-T2BM6B			R2052	J24205102	RES. Chip	1/10W	1k ohm
Q2003	G1090847	IC	HD404418A01F			R2053	J24205104	RES. Chip	1/10W	100k ohm
Q2004	G3316237F	Transistor	2SC1623-T2B L6			R2054	J24205223	RES. Chip	1/10W	22k ohm
Q2005	G3206247D	Transistor	2SB624-T2B BV4			R2055	J24205154	RES. Chip	1/10W	150k ohm
Q2006	G3316237F	Transistor	2SC1623-T2B L6			R2056	J24205154	RES. Chip	1/10W	150k ohm
D2001	G2070003	Diode	1SS226 TE85R			R2057	J24205154	RES. Chip	1/10W	150k ohm
D2002	G2070009	Diode	1SS184 TE85R			R2058	J24205223	RES. Chip	1/10W	22k ohm
D2003	G2070009	Diode	1SS184 TE85R			R2059	J24205154	RES. Chip	1/10W	150k ohm
D2004	G2070009	Diode	1SS184 TE85R			R2060	J24205154	RES. Chip	1/10W	150k ohm
D2005	G2070009	Diode	1SS184 TE85R			R2061	J24205223	RES. Chip	1/10W	22k ohm
D2006	G2070009	Diode	1SS184 TE85R			R2062	J24205154	RES. Chip	1/10W	150k ohm
D2007	G2070009	Diode	1SS184 TE85R			R2063	J24205154	RES. Chip	1/10W	150k ohm
D2008	G2090118	Diode	1SS97			R2064	J24205154	RES. Chip	1/10W	150k ohm
D2009	G2090118	Diode	1SS97			R2065	J24205223	RES. Chip	1/10W	22k ohm
D2010	G2070009	Diode	1SS184 TE85R			R2066	J24205223	RES. Chip	1/10W	22k ohm
H2001	H0102859	XTAL	HT38	8.0MHz		R2067	J24205154	RES. Chip	1/10W	150k ohm
R2001	J24205821	RES. Chip	1/10W	820 ohm		R2068	J24205154	RES. Chip	1/10W	150k ohm
R2002	J24205101	RES. Chip	1/10W	100 ohm		R2069	J24205154	RES. Chip	1/10W	150k ohm
R2003	J24205472	RES. Chip	1/10W	4.7k ohm		R2070	J24205154	RES. Chip	1/10W	150k ohm
R2004	J24205102	RES. Chip	1/10W	1k ohm		R2071	J24205154	RES. Chip	1/10W	150k ohm
R2005	J24205103	RES. Chip	1/10W	10k ohm		R2072	J24205154	RES. Chip	1/10W	150k ohm
R2006	J24205104	RES. Chip	1/10W	100k ohm		R2073	J24205154	RES. Chip	1/10W	150k ohm
R2007	J24205224	RES. Chip	1/10W	220k ohm		R2074	J24205154	RES. Chip	1/10W	150k ohm
R2008	J24205103	RES. Chip	1/10W	10k ohm		R2075	J01215154	Carbon Film RES.	1/8W	150k ohm
R2009	J24205104	RES. Chip	1/10W	100k ohm		R2076	J24205154	RES. Chip	1/10W	150k ohm
R2010	J24205105	RES. Chip	1/10W	1M ohm		VR2001	J60800142	POT.	A	20k ohm
R2011	J24205473	RES. Chip	1/10W	47k ohm		VR2002	J60800143	POT.	B	20k ohm
R2012	J24205473	RES. Chip	1/10W	47k ohm		C2001	K78130010	Tantalum. Chip		20V 2.2uF
R2014	J24205102	RES. Chip	1/10W	1k ohm		C2002	K22141809	CAP. Chip	B	25V 0.1uF
R2015	J24205103	RES. Chip	1/10W	10k ohm		C2003	K22170817	CAP. Chip	B	50V 0.01uF
R2016	J24205223	RES. Chip	1/10W	22k ohm		C2004	K22170219	CAP. Chip	CH	50V 22pF
R2017	J24205393	RES. Chip	1/10W	39k ohm		C2005	K22170219	CAP. Chip	CH	50V 22pF
R2018	J24205823	RES. Chip	1/10W	82k ohm		C2006	K78120009	Tantalum. Chip		10V 1uF
R2019	J24205103	RES. Chip	1/10W	10k ohm		C2007	K78080002	Tantalum. Chip		6.3V 4.7uF
R2020	J24215220	RES. Chip	1/8W	22 ohm		C2008	K22170817	CAP. Chip	B	50V 0.01uF
R2021	J24205683	RES. Chip	1/10W	68k ohm		C2009	K22170817	CAP. Chip	B	50V 0.01uF
R2022	J24205474	RES. Chip	1/10W	470k ohm		C2010	K22170817	CAP. Chip	B	50V 0.01uF
R2023	J24205472	RES. Chip	1/10W	4.7k ohm		C2011	K22170805	CAP. Chip	B	50V 0.01uF
R2024	J24205473	RES. Chip	1/10W	47k ohm		C2012	K78120013	Tantalum. Chip		16V 1uF
R2025	J24205103	RES. Chip	1/10W	10k ohm		C2013	K22170817	CAP. Chip	B	50V 0.01uF
R2026	J24205000	RES. Chip	1/10W	0 ohm		C2014	K22170817	CAP. Chip	B	50V 0.01uF
R2027	J24205103	RES. Chip	1/10W	10k ohm		C2015	K22170813	CAP. Chip	B	50V 0.047uF
R2028	J24205822	RES. Chip	1/10W	8.2k ohm		C2016	K22170813	CAP. Chip	B	50V 0.047uF
R2029	J24205563	RES. Chip	1/10W	56k ohm		C2017	K22170817	CAP. Chip	B	50V 0.01uF
R2030	J24205103	RES. Chip	1/10W	10k ohm		C2018	K78080003	Tantalum. Chip		6.3V 10uF
R2031	J24205274	RES. Chip	1/10W	270k ohm		C2019	K22170817	CAP. Chip	B	50V 0.01uF
R2032	J24205102	RES. Chip	1/10W	1k ohm		S2001	N5090027	Tact Switch		SKHLAB
R2033	J24205222	RES. Chip	1/10W	2.2k ohm		S2002	N5090027	Tact Switch		SKHLAB
R2034	J24205223	RES. Chip	1/10W	22k ohm		S2003	N5090027	Tact Switch		SKHLAB
R2035	J24205223	RES. Chip	1/10W	22k ohm		S2004	N5090027	Tact Switch		SKHLAB
R2036	J24205393	RES. Chip	1/10W	39k ohm		S2005	N5090027	Tact Switch		SKHLAB
R2037	J24205103	RES. Chip	1/10W	10k ohm		S2006	N5090027	Tact Switch		SKHLAB
R2038	J24205103	RES. Chip	1/10W	10k ohm		S2007	N5090027	Tact Switch		SKHLAB
R2039	J24205104	RES. Chip	1/10W	100k ohm		S2008	N5090027	Tact Switch		SKHLAB
R2040	J24205104	RES. Chip	1/10W	100k ohm		S2009	N5090027	Tact Switch		SKHLAB
						S2010	N4090111	Push Switch		SPEALZ
						S2011	Q9000395	Rotary Encoder		EVQ-WWNF1524B
						J2001	P0090642	Connector		
						J2002	P0090643	Connector		
						J2003	P0090650	Connector		
						J2004	P0090649	Connector		
						J2005	P0090158	Connector		(MIC)
							Q7000078	LCD UNIT		AM882
						BAT2001	Q9000366	Lithium Battery		
							R7124300	Press Board		
							R8118690	Seal		
							T9205637	Wire-ASSY		

# PARTS LIST

Symbol No.	Part No.	Description	Device
	Q1000065	Lamp	9V 60mA
<b>PA UNIT</b>			
	F2934120B	Printed Circuit Board	
	C029342AA	PCB with Component (45W Model)	
	C029342AB	PCB with Component (10W Model)	
Q701	G1090251	IC ⊙	M57715
	G1090625	IC ▲	M57726
D701	G2090232	Diode	S11B
D702	G2090345	Diode ⊙	MI407
	G2090425	Diode ▲	UM9415
D703	G2090337	Diode	MI308
D704	G2090118	Diode	1SS97
D705	G2090377	Diode	1SS108
R701	J01275151	CAP. Chip	1/10W 150 ohm
R702	J24205103	CAP. Chip	1/10W 10k ohm
R703	J24205223	CAP. Chip	1/10W 22k ohm
R704	J24205101	CAP. Chip	1/10W 100 ohm
VR701	J50770221	POT.	220 ohm
C701	K40129012	AL. Electro. CAP.	16V 10uF
C702	K22170805	CAP. Chip	B 50V 0.001uF
C703	K22170805	CAP. Chip	B 50V 0.001uF
C705	K22170805	CAP. Chip	B 50V 0.001uF
C706	K40129012	AL. Electro. CAP.	16V 10uF
C707	K22170211	CAP. Chip	CH 50V 10pF
C708	K22170805	CAP. Chip	B 50V 0.001uF
C709	K22170805	CAP. Chip	B 50V 0.001uF
C710	K22170805	CAP. Chip	B 50V 0.001uF
C711	K22170213	CAP. Chip	CH 50V 12pF
C712	K22170225	CAP. Chip	CH 50V 39pF
C713	K22170202	CAP. Chip	CH 50V 1pF
C714	K22170204	CAP. Chip	CH 50V 3pF
C715	K22170805	CAP. Chip	B 50V 0.001uF
C716	K22170221	CAP. Chip	CH 50V 27pF
C717	K22170229	CAP. Chip ⊙	CH 50V 56pF
	K22170221	CAP. Chip ▲	CH 50V 27pF
C718	K22170805	CAP. Chip	B 50V 0.001uF
C719	K22170805	CAP. Chip	B 50V 0.001uF
C720	K22170217	CAP. Chip	CH 50V 18pF
C721	K22170801	CAP. Chip	B 50V 470pF
C722	K22170207	CAP. Chip	CH 50V 6pF
C723	K22170221	CAP. Chip	CH 50V 27pF
C724	K22170221	CAP. Chip	CH 50V 27pF
J701	P1090599	Connector	
J702	P1090600	Connector	
J703	P1090603	Connector	
<b>ACCESSORIES</b>			
Symbol No.	Part No.	Description	Device
	T9015605	DC Cord ⊙	
	T9015615	DC Cord ▲	
	Q0000005	Fuse ⊙	5A 2 pcs
	Q0000008	Fuse ▲	15A 2 pcs
	D1000067	MIC ●	MH-14D8
	D1000051	MIC ▲	MH-14A8
	D1000052	MIC ▲	MH-14B8
	D1000067	MIC ▲	MH-14D8
	D1000060	MIC ▲	MH-15C8
	D1000061	MIC ▲	MH-15D8
	D6000055	Mobile Bracket	MMB-36
	D6000056	Mobile Bracket ▲	MMB-37

⊙ : 10W Model

▲ : 45W Model

● : Version F

▲ : Version A1, A2, A3, A4, B : One of these MICROPHONE will be supplied is per local requirement.

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